

EXAMINED BY :	EMERGING DISPLAY TECHNOLOGIES CORPORATION	FILE NO . CAS-0008671
Lucica Lu		ISSUE : JUN.26, 2018
APPROVED BY:		TOTAL PAGE : 25
Vincent Wh		VERSION : 1

CUSTOMER ACCEPTANCE SPECIFICATIONS

MODEL NO. :
ET0430G8DM6
 (RoHS)
 FOR MESSRS :

CUSTOMER'S APPROVAL

DATE :

BY :

EMERGING DISPLAY
TECHNOLOGIES CORPORATION

MODEL NO.	VERSION	PAGE
ET0430G8DM6	1	0-1

RECORDS OF REVISION

DOC . FIRST ISSUE

JUN.26, 2018

DATE	REVISED PAGE NO.	SUMMARY
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1. GENERAL SPECIFICATIONS

1.1 DATA SHEETS FOR CONTROLLER/DRIVER

PLEASE REFER TO :

SITRONIX ST7282

1.2 MATERIAL SAFETY DESCRIPTION

ASSEMBLIES SHALL COMPLY WITH EUROPEAN ROHS REQUIREMENTS, INCLUDING PROHIBITED MATERIALS/COMPONENTS CONTAINING LEAD, MERCURY, CADMIUM, HEXAVALENT CHROMIUM, POLYBROMINATED BIPHENYLS (PBB) AND POLYBROMINATED DIPHENYL ETHERS (PBDE)

2. MECHANICAL SPECIFICATIONS

(1) DIAGONALS	-----	4.3 inch
(2) NUMBER OF DOTS	-----	480W * (RGB) * 272H DOTS
(3) MODULE SIZE	-----	105.5W * 67.2H *7.95D(MAX.) mm
		(WITHOUT FPC)
(4) VIEWING AREA	-----	98.7W * 57.0H mm
(5) ACTIVE AREA	-----	95.04W * 53.856H mm
(6) DOT SIZE	-----	0.066W * 0.198H mm
(7) PIXEL SIZE	-----	0.198W * 0.198H mm
(8) LCD TYPE	-----	TFT , TRANSMISSIVE
(9) COLOR	-----	262K
(10) VIEWING DIRECTION	-----	6 O'CLOCK (GRAY LEVEL INVERSION)
(11) BACK LIGHT	-----	LED , COLOR : WHITE
(12) INTERFACE MODE	-----	RGB 18 BIT PARALLEL

3. ABSOLUTE MAXIMUM RATINGS

3.1 LCD MODULE ELECTRICAL ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	MIN.	MAX.	UNIT	REMARK
POWER SUPPLY VOLTAGE	VDD-VSS	-0.3	4.0	V	
STATIC ELECTRICITY	—	—	—	V	NOTE (1)
LED BACKLIGHT POWER DISSIPATION	PD	—	1020	W	
LED BACKLIGHT FORWARD CURRENT	IF	—	50	mA	

NOTE (1): LCD SHOULD BE GROUNDED DURING HANDLING LCM.

3.2 ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS

ITEM	OPERATING		STORAGE		REMARK
	MIN.	MAX.	MIN.	MAX.	
AMBIENT TEMPERATURE	-20°C	70°C	-30°C	80°C	NOTE (1), (2)
HUMIDITY	NOTE (3)		NOTE (3)		WITHOUT CONDENSATION
VIBRATION	—	3.92 m/s ² (0.4 G)	—	19.6 m/s ² (2.0 G)	10~55Hz X, Y, Z, EACH 2HRS
SHOCK	—	58.8 m/s ² (6 G)	—	980 m/s ² (100 G)	6 ms XYZ DIRECTIONS 3 TIMES EACH
CORROSIVE GAS	NOT ACCEPTABLE		NOT ACCEPTABLE		

NOTE (1) : Ta AT -30°C : WILL BE 48HRS MAX.

80°C : WILL BE 168HRS MAX.

NOTE (2) : BACKGROUND COLOR CHANGES SLIGHTLY DEPENDING ON AMBIENT
TEMPERATURE THIS PHENOMENON IS REVERSIBLE.

NOTE (3) : Ta ≤ 60°C : 90%RH MAX (96HRS MAX).

Ta > 60°C : ABSOLUTE HUMIDITY MUST BE LOWER THAN THE HUMIDITY
OF 90%RH AT 60°C (96HRS MAX).

4. ELECTRICAL CHARACTERISTICS

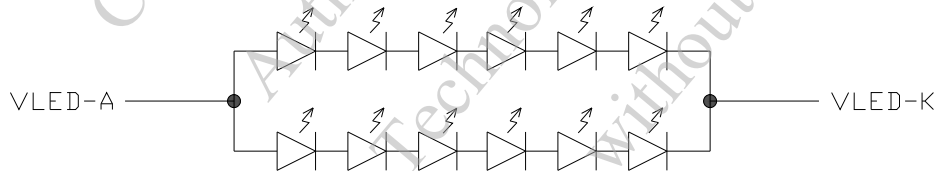
Ta = 25 °C

PARAMETER	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REMARK
POWER SUPPLY VOLTAGE	VDD-VSS	—	3.0	3.3	3.6	V	
POWER SUPPLY VOLTAGE FOR LED DRIVER	VCC-VSS	—	2.7	3.3	5.5	V	
LOGIC HIGH INPUT VOLTAGE	VIH	—	0.7*VDD	—	VDD	V	NOTE (1)
LOGIC LOW INPUT VOLTAGE	VIL	—	0	—	0.3*VDD	V	
POWER SUPPLY CURRENT	IDD	VDD-VSS=3.3V	—	15	20	mA	NOTE (2)
POWER SUPPLY CURRENT FOR LED DRIVER	ICC	VCC-VSS=3.3V LED B/L=ON	—	390	510	mA	
POWER SUPPLY FOR LED BACKLIGHT	VF	IF = 40mA	16.8	19.2	20.4	V	NOTE (3)
LED LIFE TIME	—	I _{LED} =20mA (PER. LED)	30K	—	—	HRS	NOTE (4) NOTE (5)

NOTE (1) : APPLIED TO TERMINALS B5~B0, G5~G0, R5~R0, DCLK, HSYNC, VSYNC, ENB.

NOTE (2) : THE DISPLAY PATTERN IS ALL "WHITE"

NOTE (3) : INTERNAL CIRCUIT DIAGRAM OF BACKLIGHT



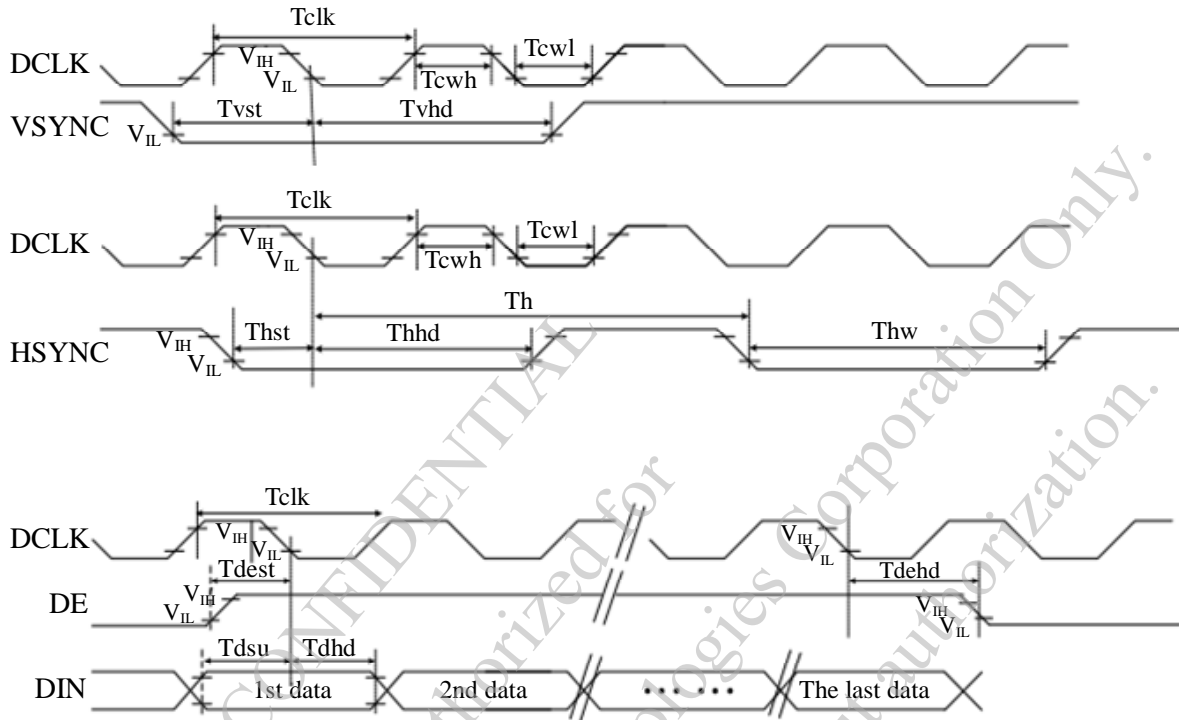
NOTE (4) : CONDITIONS; TA=25 °C, CONTINUOUS LIGHTING

NOTE (5) : DEFINITIONS OF LIFE TIME :

LCM LUMINANCE BECOMES HALF OF THE INITIAL VALUE.

5. TIMING CHARACTERISTICS

5.1 CLOCK AND DATA INPUT TIMING DIAGRAM

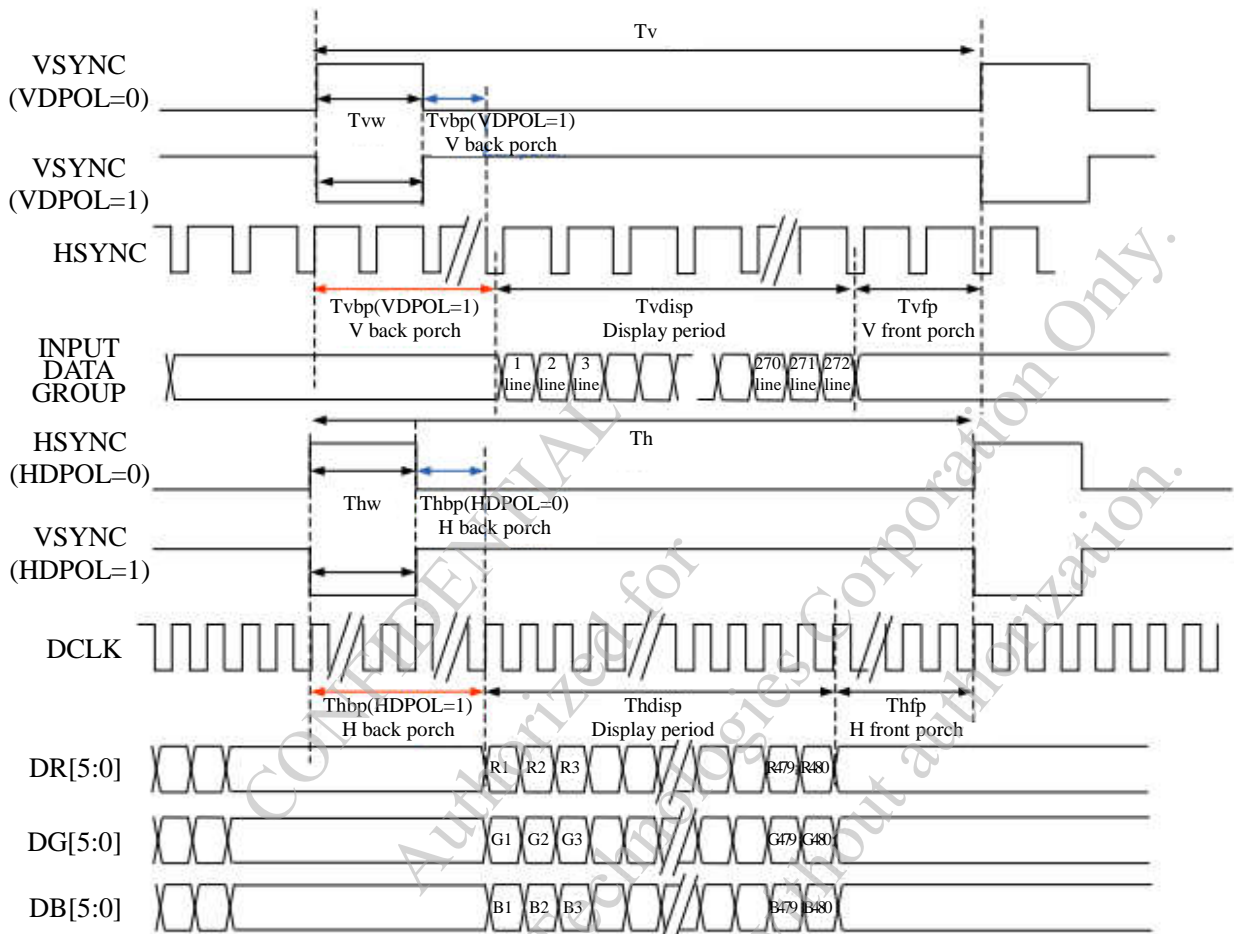


5.2 PARALLEL RGB TIMING TABLE

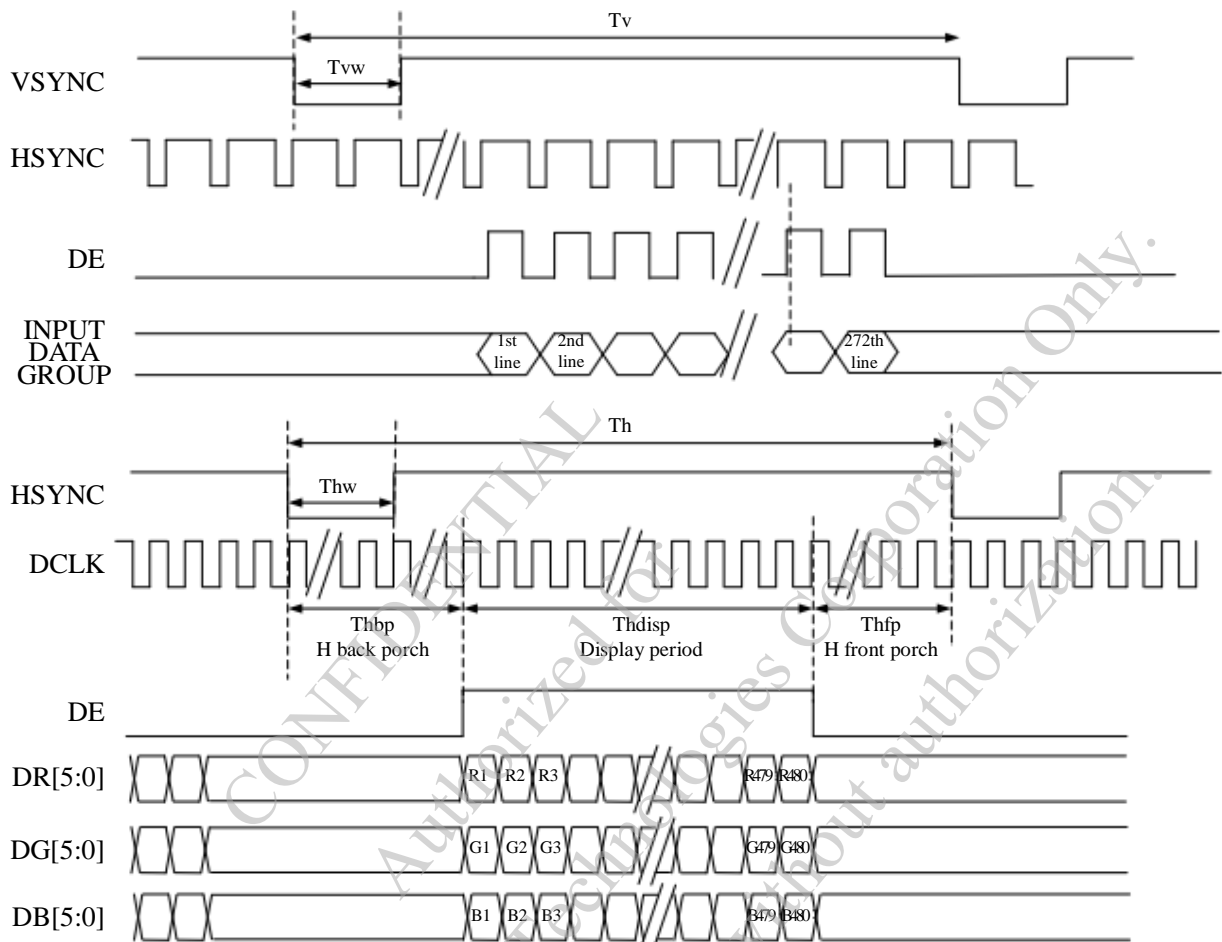
ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT	REMARK	
DCLK FREQUENCY	Fclk	8	9	12	MHz		
DCLK PERIOD	Tclk	83	111	125	ns		
HSYNC	PERIOD TIME	T_h	485	531	598	DCLK	
	DISPLAY PERIOD	T_{hdisp}	—	480	—	DCLK	
	BACK PORCH	T_{hbp}	3	43	43	DCLK	BY H_BLANKING SETTING
	FRONT PORCH	T_{hfp}	2	8	75	DCLK	
	PULSE WIDTH	T_{hw}	2	4	75	DCLK	
VSYNC	PERIOD TIME	T_v	276	292	321	H	
	DISPLAY PERIOD	T_{vdisp}	—	272	—	H	
	BACK PORCH	T_{vbp}	2	12	12	H	BY V_BLANKING SETTING
	FRONT PORCH	T_{vfp}	2	8	37	H	
	PULSE WIDTH	T_{vw}	2	4	37	H	

NOTE : IT IS NECESSARY TO KEEP $T_{vbp}= 12$ AND $T_{hbp}=43$ IN SYNC MODE. DE MODE IS UNNECESSARY TO KEEP IT.

5.3 SYNC MODE TIMING DIAGRAM

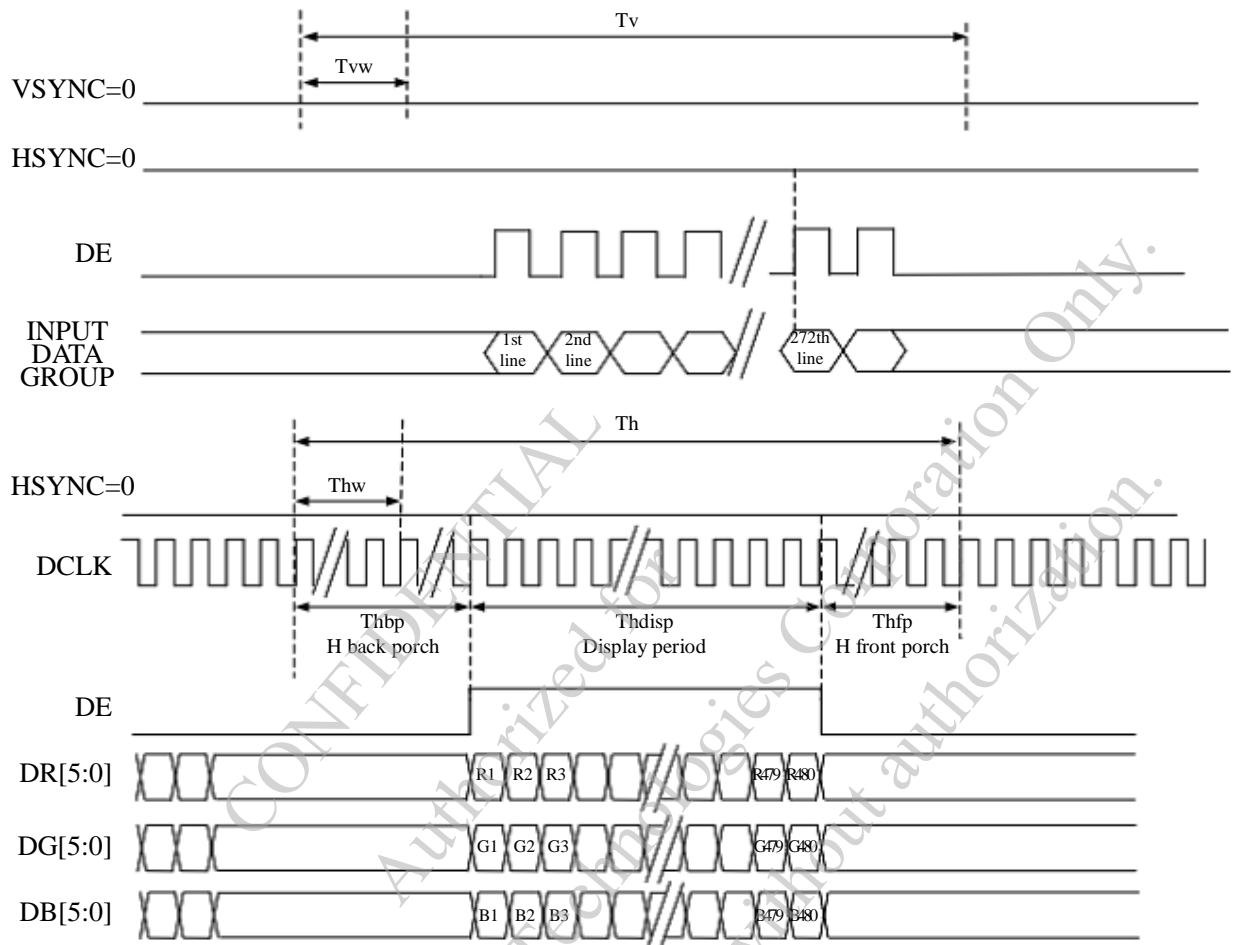


5.4 SYNC-DE MODE TIMING DIAGRAM



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5.5 DE MODE TIMING DIAGRAM



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6. OPTICAL CHARACTERISTICS (NOTE 1)

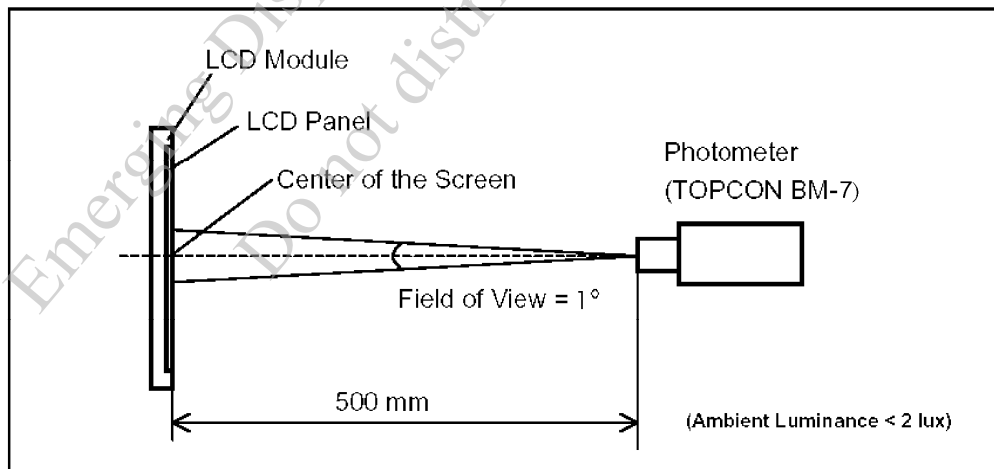
6.1 OPTICAL CHARACTERISTICS

Ta = 25°C

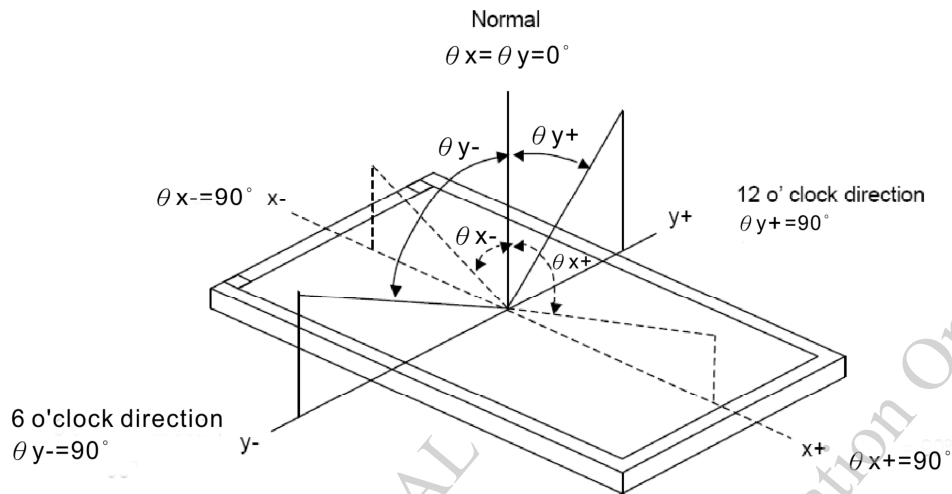
ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REMARK	
VIEWING ANGLE	θ_{y+}	CR ≥ 10	$\theta_x=0^\circ$	50	60	—	deg.	NOTE (2) NOTE (3)
	θ_{y-}			60	70	—		
	θ_{x+}		$\theta_y=0^\circ$	60	70	—		
	θ_{x-}			60	70	—		
CONTRAST RATIO	CR	$\theta_x=0^\circ, \theta_y=0^\circ$	400	600	—	—	NOTE (3)	
RESPONSE TIME	tr (rise) + tf (fall)	$\theta_x=0^\circ, \theta_y=0^\circ$	—	25	40	msec	NOTE (4)	
COLOR OF CIE COORDINATE	WHITE	Wx	$\theta_x=0^\circ, \theta_y=0^\circ$ IF = 40mA (NTSC : 50%)	0.250	0.300	0.350	—	NOTE (5)
		Wy		0.270	0.320	0.370		
	RED	Rx		0.535	0.586	0.635	—	
		Ry		0.314	0.364	0.414		
	GREEN	Gx		0.283	0.333	0.383	—	
		Gy		0.508	0.558	0.608		
	BLUE	Bx		0.100	0.150	0.200	—	
		By		0.010	0.060	0.110		
THE BRIGHTNESS OF MODULE	B	$\theta_x=0^\circ, \theta_y=0^\circ$ IF = 40mA	450	500	—	cd/m ²	NOTE (6)	
THE BRIGHTNESS OF UNIFORMITY	—	$\theta_x=0^\circ, \theta_y=0^\circ$ IF = 40mA	70	75	—	%		

NOTE (1) : TEST EQUIPMENT SETUP :

AFTER STABILIZING AND LEAVING THE PANEL ALONE AT A GIVEN TEMPERATURE FOR 30 MINUTES. MEASUREMENT SHOULD BE EXECUTED IN A STABLE, WINDLESS, AND DARK ROOM. OPTICAL SPECIFICATIONS ARE MEASURED BY TOPCON BM-7 (FAST) WITH A VIEWING ANGLE OF 1° AT A DISTANCE OF 50cm AND NORMAL DIRECTION.



NOTE (2) : DEFINITION OF VIEWING ANGLE :

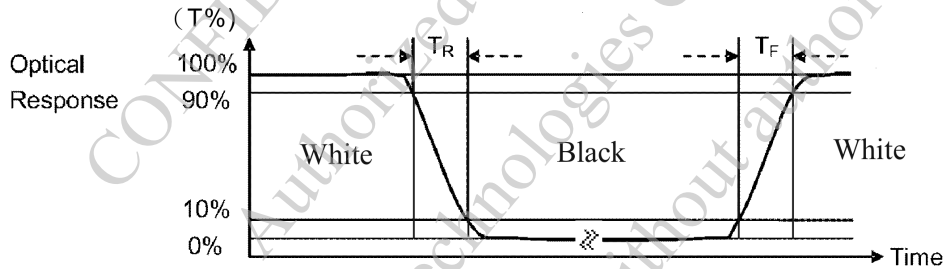


NOTE (3) : DEFINITION OF CONTRAST RATIO :

$$\text{CONTRAST RATIO (CR)} = \frac{\text{BRIGHTNESS MEASURED WHEN LCD IS AT "WHITE STATE"}}{\text{BRIGHTNESS MEASURED WHEN LCD IS AT "BLACK STATE"}}$$

NOTE (4) : DEFINITION OF RESPONSE TIME : TR AND TF

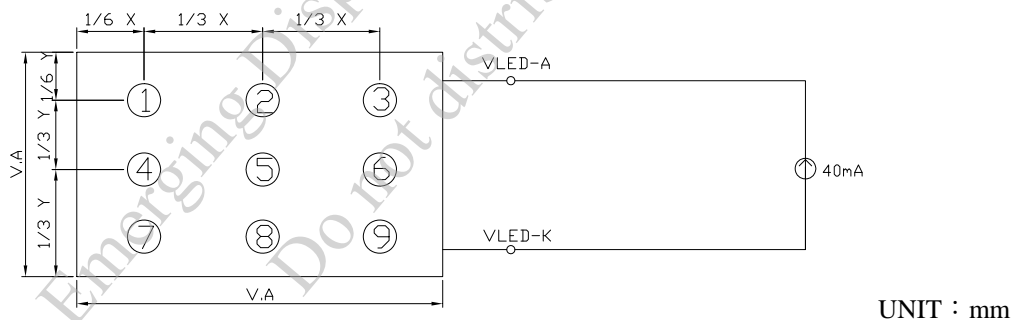
THE FIGURE BELOW IS THE OUTPUT SIGNAL OF THE PHOTO DETECTOR.



NOTE (5) : BRIGHTNESS MEASURED WHEN LCD IS AT "WHITE STATE".

NOTE (6) : THE 100% TRANSMISSION IS DEFINED AS THE TRANSMISSION OF LCD PANEL WHEN ALL THE INPUT TERMINALS OF MODULE ARE ELECTRICALLY OPENED.

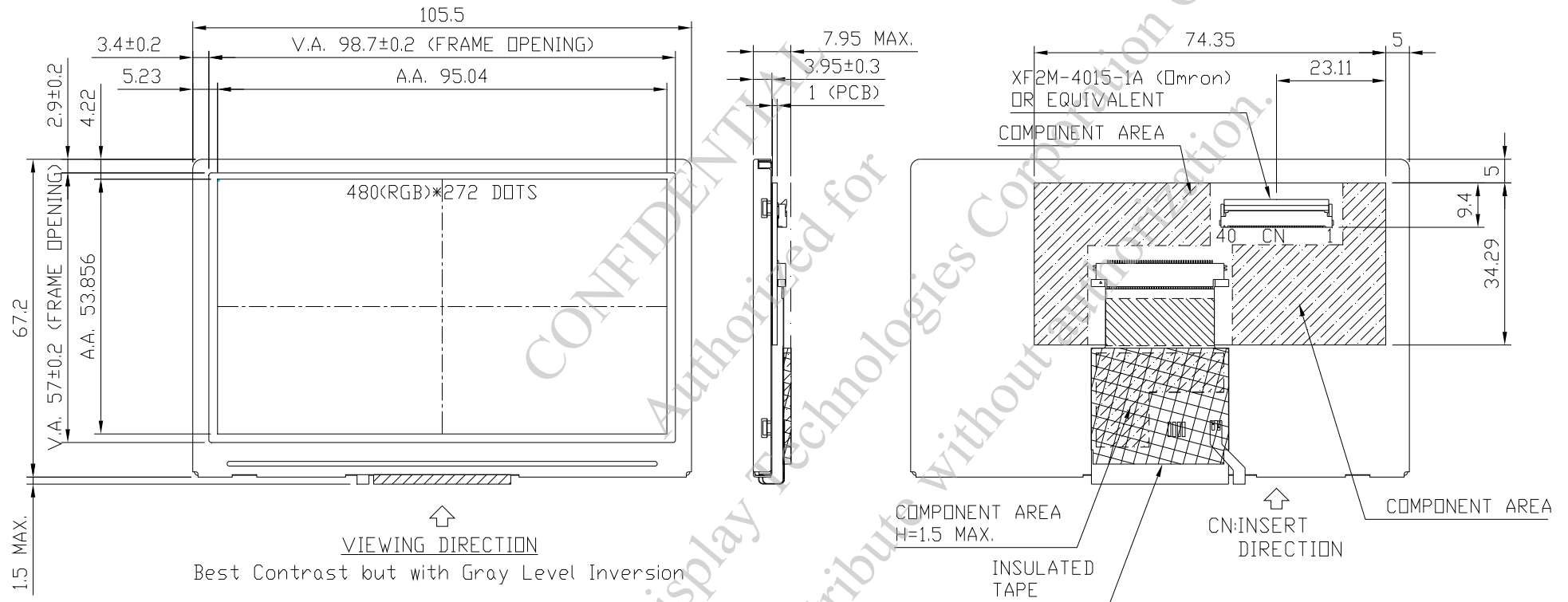
6.2 THE BRIGHTNESS TEST METHOD



6.3 THE BRIGHTNESS UNIFORMITY CALCULATE METHOD

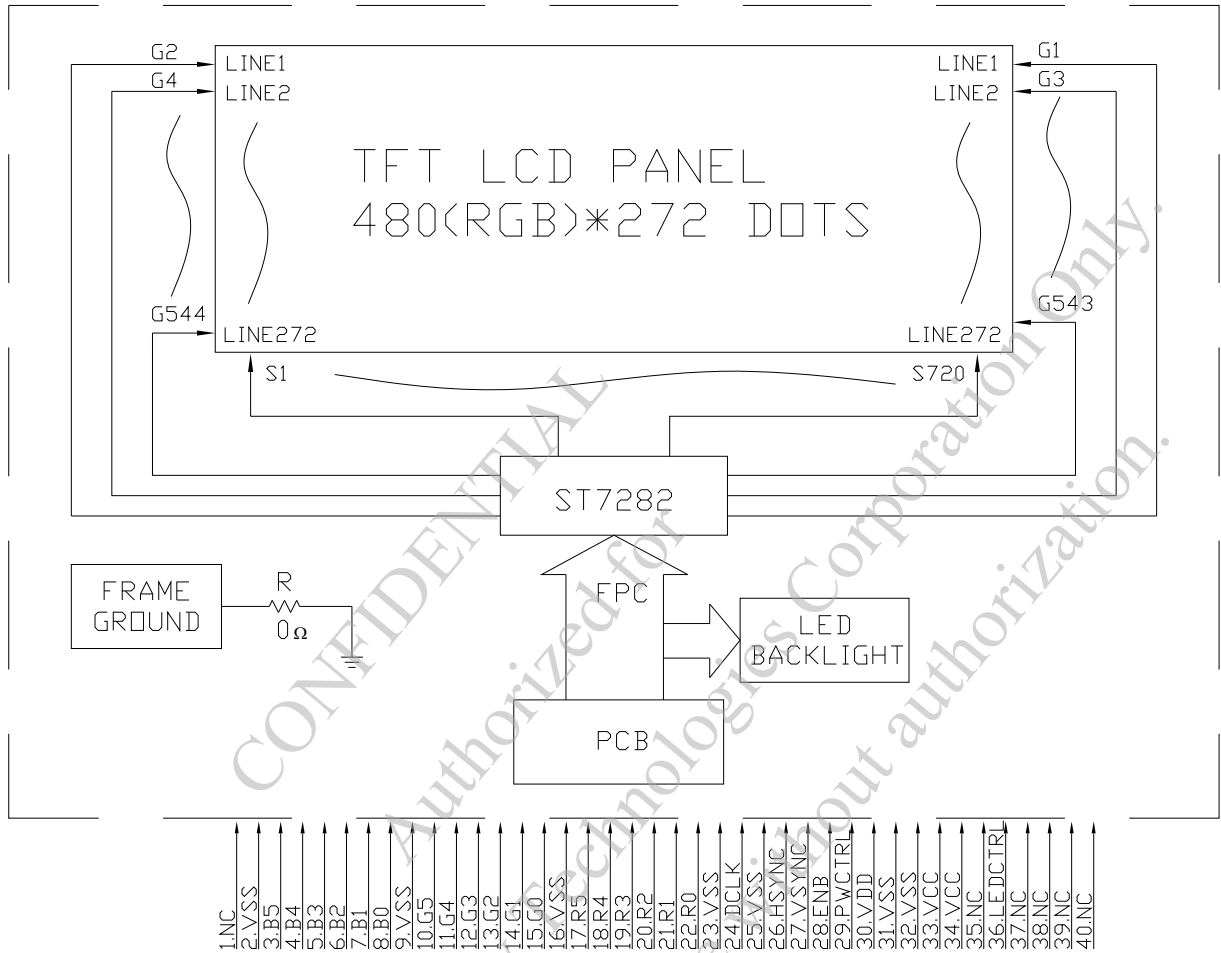
$$\text{UNIFORMITY} = \left[1 - \frac{\text{MAXIMUM BRIGHTNESS} - \text{MINIMUM BRIGHTNESS}}{\text{AVERAGE BRIGHTNESS}} \right] \times 100\%$$

7. OUTLINE DIMENSIONS

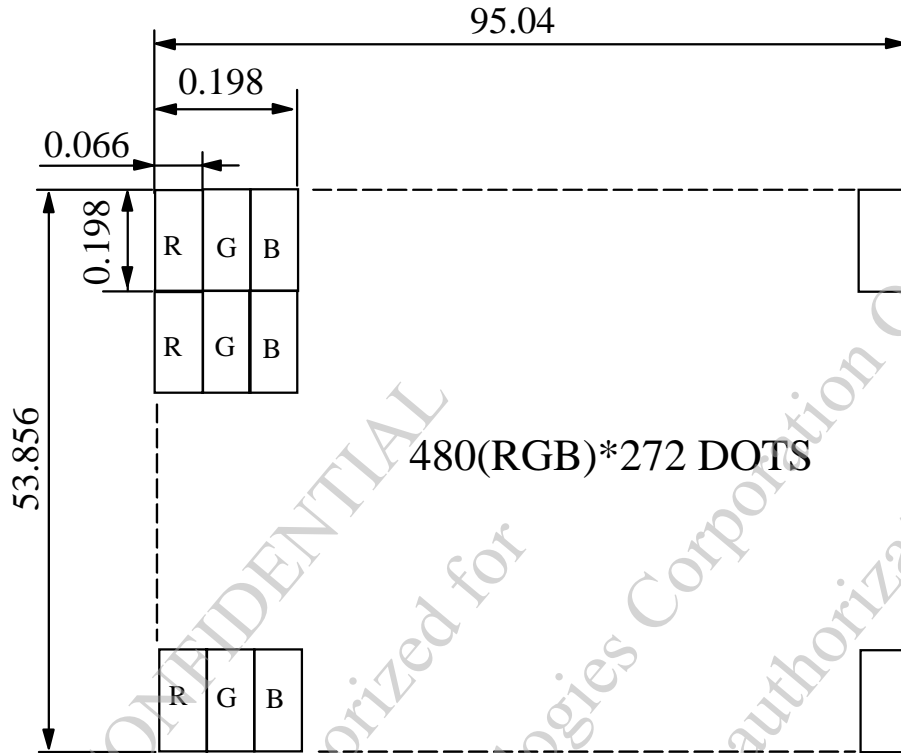


UNIT : mm
SCALE : NTS
NOT SPECIFIED TOLERANCE IS ±0.3mm

8. BLOCK DIAGRAM



9. DETAIL DRAWING OF DOT MATRIX



UNIT : mm
SCALE : NTS
NOT SPECIFIED TOLERANCE IS ± 0.1
DOTS MATRIX TOLERANCE IS ± 0.01

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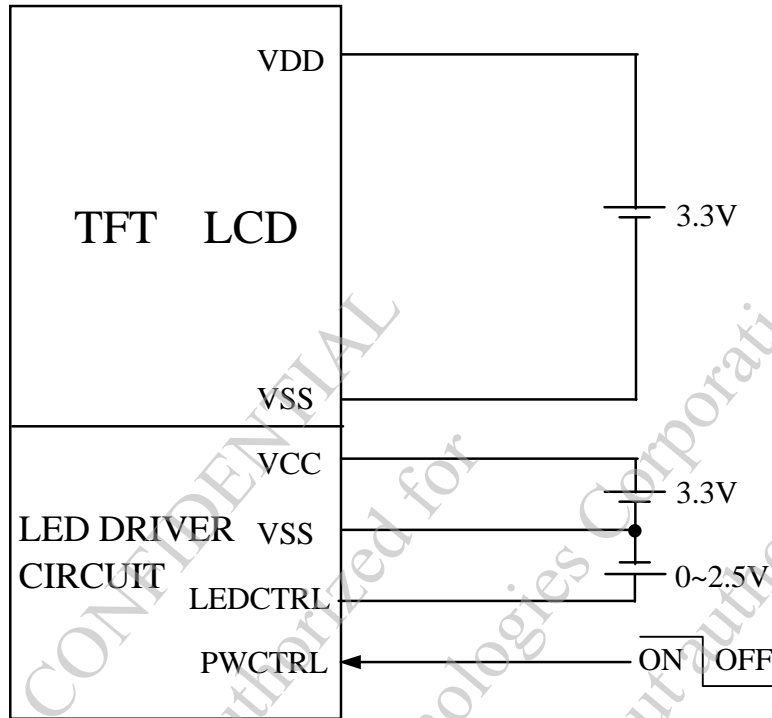
10. INTERFACE SIGNALS

PIN NO	SYMBOL	I/O/P	FUNCTION
1	NC	—	NON CONNECTION
2	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)
3	B5	I	BLUE DATA BIT 5
4	B4	I	BLUE DATA BIT 4
5	B3	I	BLUE DATA BIT 3
6	B2	I	BLUE DATA BIT 2
7	B1	I	BLUE DATA BIT 1
8	B0	I	BLUE DATA BIT 0
9	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)
10	G5	I	GREEN DATA BIT 5
11	G4	I	GREEN DATA BIT 4
12	G3	I	GREEN DATA BIT 3
13	G2	I	GREEN DATA BIT 2
14	G1	I	GREEN DATA BIT 1
15	G0	I	GREEN DATA BIT 0
16	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)
17	R5	I	RED DATA BIT 5
18	R4	I	RED DATA BIT 4
19	R3	I	RED DATA BIT 3
20	R2	I	RED DATA BIT 2
21	R1	I	RED DATA BIT 1
22	R0	I	RED DATA BIT 0
23	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)
24	DCLK	I	DOT DATA CLOCK
25	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)
26	HSYNC	I	HORIZONTAL SYNC INPUT WITH NEGATIVE POLARITY. INTERNALLY PULL HIGH.
27	VSYNC	I	VERTICAL SYNC INPUT WITH NEGATIVE POLARITY. INTERNALLY PULL HIGH.
28	ENB	I	INPUT DATA ENABLE CONTROL. INTERNALLY PULLED LOW.

PIN NO	SYMBOL	I/O/P	FUNCTION		
				PWCTRL	REMARK
29	PWCTRL	I	LOGIC LEVEL H=3.3V L=0V	H	POWER ON
				L	SHUTDOWN
			WHEN INTERNAL LED DRIVER : JP4 1-2(DEFAULT) WHEN EXTERNAL LED DRIVER : JP4 2-3		
30	VDD	P	POWER SUPPLY VOLTAGE		
31	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)		
32	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)		
33	VCC	P	POWER SUPPLY FOR LED DRIVER CIRCUIT		
34	VCC	P	POWER SUPPLY FOR LED DRIVER CIRCUIT		
35	NC	—	NON CONNECTION (USING INTERNAL LED DRIVER) OR ANODE (USING EXTERNAL LED DRIVER) WHEN INTERNAL LED DRIVER : JP1 1-2 (DEFAULT) WHEN EXTERNAL LED DRIVER : JP1 2-3		
36	LEDCTRL	I	BRIGHTNESS CONTROL FOR LED BACKLIGHT ; LEDCTRL (USING INTERNAL LED DRIVER) OR CATHODE (USING EXTERNAL LED DRIVER) WHEN INTERNAL LED DRIVER : JP2 1-2 (DEFAULT) JP3 1-2 CONNECT(DEFAULT) WHEN EXTERNAL LED DRIVER : JP2 2-3 JP3 NON CONNECTION		
37	NC	—	NON CONNECTION		
38	NC	—	NON CONNECTION		
39	NC	—	NON CONNECTION		
40	NC	—	NON CONNECTION		

11. POWER SUPPLY

11.1 POWER SUPPLY FOR LCM



11.2 THE BRIGHTNESS CONTROLLED BY BACKLIGHT CURRENT OF LEDCTRL

TBD

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12. INSPECTION CRITERION

12.1 APPLICATION

THIS INSPECTION STANDARD IS TO BE APPLIED TO THE LCD MODULE DELIVERED FROM EMERGING DISPLAY TECHNOLOGIES CORP.(E.D.T) TO CUSTOMERS

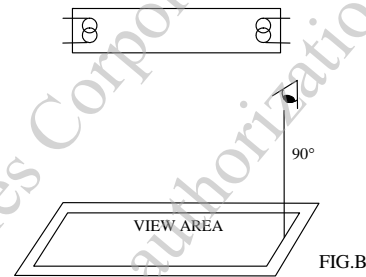
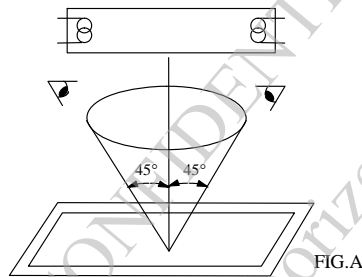
12.2 INSPECTION CONDITIONS

12.2.1 (1)OBSERVATION DISTANCE : 45±5cm

(2)VIEWING ANGLE : ±45°

±45° (FOR SECTION WITHIN VIEWING AREA), REFER TO FIG.A
90° (FOR SECTION OUTSIDE OF VIEWING AREA), REF TO FIG.B
PERPENDICULAR TO MODULE SURFACE

VIEWING ANGLE SHOULD BE SMALLER THAN 45°



THE INSPECTION CRITERIA IS ACCORDING TO LINE OF SIGHT. INSPECTION SHALL BE MADE WITHIN THE HALF SECTION OF THE VIEWING CONE GENERATED BY LINE SEGMENT OF 45° WITH RESPECTS TO THE VERTICAL AXIS FROM CENTER VERTEX OF LCD, THE FLUORESCENT LAMP AND THE CONE AXIS MUST BE PERPENDICULAR TO THE LCD SURFACE.

IF THE DEFECTS ARE OUTSIDE OF VIEWING AREA, IT SHALL BE INSPECTED BY 90° WITH RESPECTS TO THE VERTICAL AXIS FROM EDGE OF VIEWING AREA.

12.2.2 ENVIRONMENT CONDITIONS :

AMBIENT TEMPERATURE		25±5°C
AMBIENT HUMIDITY		65 ± 20%RH
AMBIENT ILLUMINATION	COSMETIC INSPECTION	600~800 lux
	FUNCTIONAL INSPECTION	300~500 lux
INSPECTION TIME		10 secs

12.2.3 INSPECTION LOT

QUANTITY PER DELIVERY LOT FOR EACH MODEL

12.2.4 INSPECTION METHOD

A SAMPLING INSPECTION SHALL BE MADE ACCORDING TO THE FOLLOWING PROVISIONS TO JUDGE THE ACCEPTABILITY

(a)APPLICABLE STANDARD :

ANSI/ ASQ Z1.4 NORMAL INSPECTION LEVEL II

(b)AQL : MAJOR DEFECT : AQL 0.65

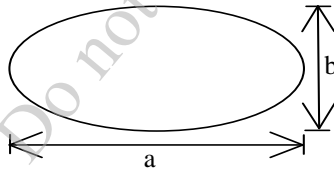
MINOR DEFECT : AQL 1.0

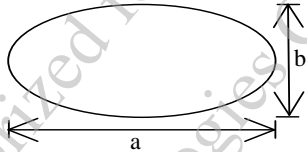
12.3 INSPECTION STANDARDS

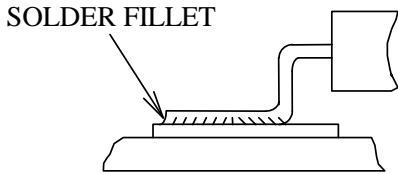
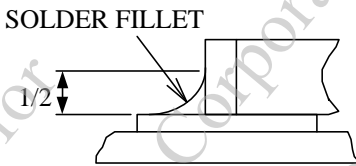
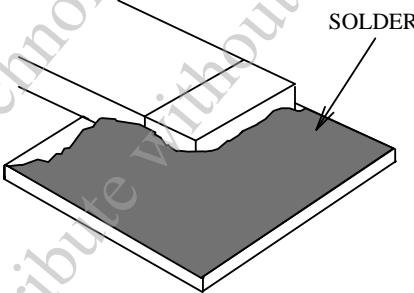
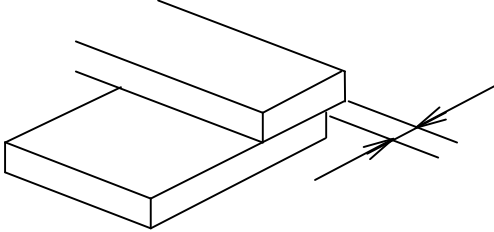
12.3.1 VISUAL DEFECTS CLASSIFICATION

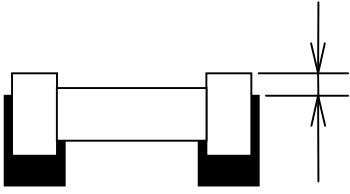
TYPE OF DEFECT	INSPECTION ITEM	DEFECT FEATURE	AQL
MAJOR DEFECT	1.DISPLAY ON	<ul style="list-style-type: none"> • DEFECT TO MISS SPECIFIED DISPLAY FUNCTION, FOR ALL AND SPECIFIED DOTS EX: DISCONNECTION, SHORT CIRCUIT ETC 	0.65
	2.BACKLIGHT	<ul style="list-style-type: none"> • NO LIGHT • FLICKERING AND OTHER ABNORMAL ILLUMINATION 	
	3.DIMENSIONS	<ul style="list-style-type: none"> • SUBJECT TO INDIVIDUAL ACCEPTANCE SPECIFICATIONS 	
MINOR DEFECT	1.DISPLAY ZONE	<ul style="list-style-type: none"> • BLACK/WHITE SPOT • BUBBLES ON POLARIZER • NEWTON RING • BLACK/WHITE LINE • SCRATCH • CONTAMINATION • LEVER COLOR SPREAD 	1.0
	2.BEZEL ZONE	<ul style="list-style-type: none"> • STAINS • SCRATCHES • FOREIGN MATTER 	
	3.SOLDERING	<ul style="list-style-type: none"> • INSUFFICIENT SOLDER • SOLDERED IN INCORRECT POSITION • CONVEX SOLDERING SPOT • SOLDER BALLS • SOLDER SCRAPS 	
	4.DISPLAY ON (ALL ON)	<ul style="list-style-type: none"> • LIGHT LINE 	

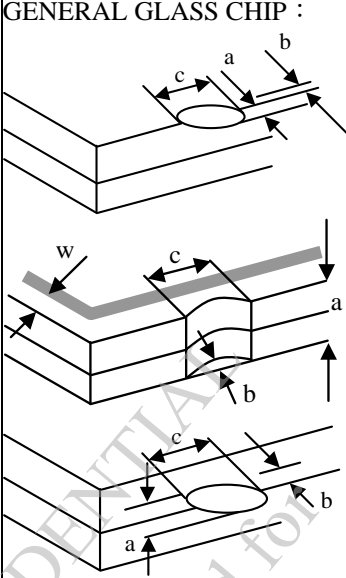
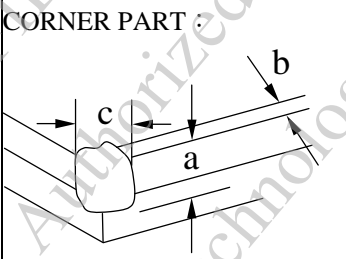
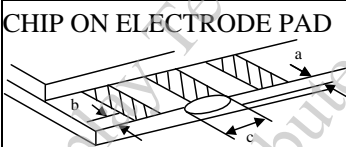
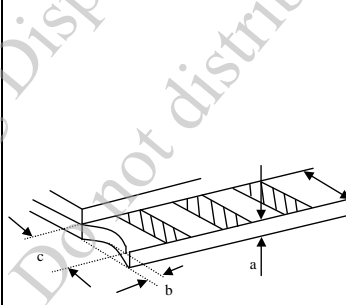
12.3.2 MODULE DEFECTS CLASSIFICATION

NO.	ITEM	CRITERIA												
1	DISPLAY ON INSPECTION	1. INCORRECT PATTERN 2. MISSING SEGMENT 3. DIM SEGMENT 4. OPERATING VOLTAGE BEYOND SPEC												
2	OVERALL DIMENSIONS	1. OVERALL DIMENSION BEYOND SPEC												
3	DOT DEFECT	<p>1. INSPECTION PATTERN: FULL WHITE, FULL BLACK, RED, GREEN AND BLUE SCREENS.</p> <p>2.</p> <table border="1"> <thead> <tr> <th>ITEMS</th> <th>ACCEPTABLE COUNT</th> </tr> </thead> <tbody> <tr> <td>BRIGHT DOT</td> <td>$N \leq 2$</td> </tr> <tr> <td>DARK DOT</td> <td>$N \leq 3$</td> </tr> <tr> <td>TOTAL BRIGHT AND DARK DOTS</td> <td>$N \leq 4$</td> </tr> </tbody> </table> <p>NOTE :</p> <p>1. THE DEFINITION OF DOT : THE SIZE OF A DEFECTIVE DOT OVER 1/2 OF WHOLE DOT IS REGARDED AS ONE DEFECTIVE DOT.</p> <p>2. BRIGHT DOT : DOTS APPEAR BRIGHT AND UNCHANGED IN SIZE IN WHICH LCD PANEL IS DISPLAYING UNDER BLACK PATTERN.</p> <p>3. DARK DOT : DOTS APPEAR DARK AND UNCHANGED IN SIZE IN WHICH LCD PANEL IS DISPLAYING UNDER PURE RED, GREEN, BLUE PICTURE.</p>	ITEMS	ACCEPTABLE COUNT	BRIGHT DOT	$N \leq 2$	DARK DOT	$N \leq 3$	TOTAL BRIGHT AND DARK DOTS	$N \leq 4$				
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4	FOREIGN BLACK/WHITE/ BRIGHT LINE/ SCRATCH OF VIEWING AREA	<table border="1"> <thead> <tr> <th>LENGTH : L</th> <th>WIDTH : W</th> <th>PERMISSIBLE NO.</th> </tr> </thead> <tbody> <tr> <td>$L \leq 0.3$</td> <td>$W \leq 0.05$</td> <td>IGNORE</td> </tr> <tr> <td>$0.3 < L \leq 2.5$</td> <td>$0.05 < W \leq 0.1$</td> <td>4</td> </tr> <tr> <td>$2.5 < L$</td> <td>$0.1 < W$</td> <td>NONE</td> </tr> </tbody> </table> <p>WIDTH : W mm, LENGTH : L mm</p>	LENGTH : L	WIDTH : W	PERMISSIBLE NO.	$L \leq 0.3$	$W \leq 0.05$	IGNORE	$0.3 < L \leq 2.5$	$0.05 < W \leq 0.1$	4	$2.5 < L$	$0.1 < W$	NONE
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$2.5 < L$	$0.1 < W$	NONE												
5	FOREIGN MATTER \ BLACK SPOTS \ WHITE SPOTS \ DENT (INCLUDING LIGHT LEAKAGE DUE TO POLARIZING PLATES PINHOLES, ETC.)	<table border="1"> <thead> <tr> <th>AVERAGE DIAMETER (mm): D</th> <th>NUMBER OF PIECES PERMITTED</th> </tr> </thead> <tbody> <tr> <td>$D \leq 0.15$</td> <td>IGNORE</td> </tr> <tr> <td>$0.15 < D \leq 0.5$</td> <td>4</td> </tr> <tr> <td>$0.5 < D$</td> <td>NONE</td> </tr> </tbody> </table> <p>NOTE : DIAMETER $D = (a+b)/2$</p> 	AVERAGE DIAMETER (mm): D	NUMBER OF PIECES PERMITTED	$D \leq 0.15$	IGNORE	$0.15 < D \leq 0.5$	4	$0.5 < D$	NONE				
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NO.	ITEM	CRITERIA		
			AVERAGE DIAMETER (mm) : D	NUMBER OF PIECES PERMITTED
6	BUBBLES OF POLARIZER /DIRT/CF FAIL /SURFACE STAINS	BUBBLE ON THE POLARIZER	$D \leq 0.25$	IGNORE
			$0.25 < D \leq 0.5$	$N \leq 5$
			$0.5 < D$	NONE
		SURFACE STAINS	$D < 0.1$	IGNORE
			$0.1 < D \leq 0.3$	$N \leq 3$
		CF FAIL / SPOT	$D < 0.1$	IGNORE
$0.1 < D \leq 0.3$	$N \leq 3$			
		<p>NOTE : (1)POLARIZER BUBBLE IS DEFINED AS THE BUBBLE APPEARS ON ACTIVE DISPLAY AREA. THE DEFECT OF POLARIZER BUBBLE SHALL BE IGNORED IF THE POLARIZER BUBBLE APPEARS ON THE OUTSIDE OF ACTIVE DISPLAY AREA.</p> <p>(2)THE EXTRANEOUS SUBSTANCE IS DEFINED AS IT CAN BE OBSERVED WHEN THE MODULE IS POWER ON.</p> <p>(3)THE DEFINITION OF AVERAGE DIAMETER, D IS DEFINED AS FOLLOWING.</p> <p>AVERAGE DIAMETER (D)=(a+b)/2</p> 		
7	LINE DEFECT ON DISPLAY	OBVIOUS VERTICAL OR HORIZONTAL LINE DEFECT IS NOT ALLOWED		
8	MURA ON DISPLAY	IT'S OK IF MURA IS SLIGHT VISIBLE THROUGH 6% ND FILTER		
9	UNEVEN COLOR SPREAD, COLORATION	1. TO BE DETERMINED BASED UPON THE STANDARD SAMPLE.		
10	BEZEL APPEARANCE	<p>1. BEZEL MAY NOT HAVE RUST, BE DEFORMED OR HAVE FINGER PRINTS STAINS OF OTHER CONTAMINATION.</p> <p>2. BEZEL MUST COMPLY WITH JOB SPECIFICATIONS.</p>		
11	PCB	<p>1. THERE MAY NOT BE MORE THAN 2mm OF SEALANT OUTSIDE THE SEAL AREA ON THE PCB, AND THERE SHOULD BE NO MORE THAN THREE PLACES.</p> <p>2. NO OXIDATION OR CONTAMINATION PCB TERMINALS.</p> <p>3. PARTS ON PCB MUST BE THE SAME AS ON THE PRODUCTION CHARACTERISTIC CHART. THERE SHOULD BE NO WRONG PARTS, MISSING PARTS OR EXCESS PARTS.</p> <p>4. THE JUMPER ON THE PCB SHOULD CONFORM TO THE PRODUCT CHARACTERISTIC CHART.</p> <p>5. IF SOLDER GETS ON BEZEL TAB PADS, LED PAD, ZEBRA PAD OR SCREW HOLD PAD; MAKE SURE IT IS SMOOTHED DOWN.</p>		

NO.	ITEM	CRITERIA
12	SOLDERING	<p>1. NO SOLDERING FOUND ON THE SPECIFIED PLACE</p> <p>2. INSUFFICIENT SOLDER</p> <p>(a)LSI, IC A POOR WETTING OF SOLDER IS BETWEEN LOWER BEND OR "HEEL" OF LEAD AND PAD</p>  <p>(b)CHIP COMPONENT · SOLDER IS LESS THAN 50% OF SIDES AND FRONT FACE WETTING</p>  <p>· SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED</p>  <p>3. PARTS ALIGNMENT</p> <p>(a)LSI, IC LEAD WIDTH IS MORE THAN 50% BEYOND PAD OUTLINE</p> 

NO.	ITEM	CRITERIA
12	SOLDERING	<p>(b)CHIP COMPONENT COMPONENT IS OFF CENTER, AND MORE THAN 50% OF THE LEADS IS OFF THE PAD OUTLINE</p>  <p>4. NO UNMELTED SOLDER PASTE MAY BE PRESENT ON THE PCB. 5. NO COLD SOLDER JOINTS, MISSING SOLDER CONNECTIONS, OXIDATION OR ICICLE. 6. NO RESIDUE OR SOLDER BALLS ON PCB. 7. NO SHORT CIRCUITS IN COMPONENTS ON PCB.</p>
13	BACKLIGHT	<p>1. NO LIGHT 2. FLICKERING AND OTHER ABNORMAL ILLUMINATION 3. SPOTS OR SCRATCHES THAT APPEAR WHEN LIT MUST BE JUDGED USING LCD SPOT, LINES AND CONTAMINATION STANDARDS. 4. BACKLIGHT DOESN'T LIGHT OR COLOR IS WRONG.</p>
14	GENERAL APPEARANCE	<p>1. NO OXIDATION, CONTAMINATION, CURVES OR, BENDS ON INTERFACE PIN (OLB) OF TCP. 2. NO CRACKS ON INTERFACE PIN (OLB) OF TCP. 3. NO CONTAMINATION, SOLDER RESIDUE OR SOLDER BALLS ON PRODUCT. 4. THE IC ON THE TCP MAY NOT BE DAMAGED, CIRCUITS. 5. THE UPPERMOST EDGE OF THE PROTECTIVE STRIP ON THE INTERFACE PIN MUST BE PRESENT OR LOOK AS IF IT CAUSE THE INTERFACE PIN TO SEVER. 6. THE RESIDUAL ROSIN OR TIN OIL OF SOLDERING (COMPONENT OR CHIP COMPONENT) IS NOT BURNED INTO BROWN OR BLACK COLOR. 7. SEALANT ON TOP OF THE ITO CIRCUIT HAS NOT HARDENED. 8. PIN TYPE MUST MATCH TYPE IN SPECIFICATION SHEET. 9. LCD PIN LOOSE OR MISSING PINS. 10. PRODUCT PACKAGING MUST THE SAME AS SPECIFIED ON PACKAGING SPECIFICATION SHEET. 11. PRODUCT DIMENSION AND STRUCTURE MUST CONFORM TO PRODUCT SPECIFICATION SHEET. 12. THE APPEARANCE OF HEAT SEAL SHOULD NOT ADMIT ANY DIRT AND BREAK.</p>

NO.	ITEM	CRITERIA									
15	CRACKED GLASS	<p>THE LCD WITH EXTENSIVE CRACK IS NOT ACCEPTABLE</p> <p>GENERAL GLASS CHIP :</p>  <table border="1"> <thead> <tr> <th>a</th> <th>b</th> <th>c</th> </tr> </thead> <tbody> <tr> <td>$\leq t/2$</td> <td>< VIEWING AREA</td> <td>$\leq 1/8X$</td> </tr> <tr> <td>$t/2 > , \leq 2t$</td> <td>$\leq W/2$</td> <td>$\leq 1/8X$</td> </tr> </tbody> </table> <p>*W=DISTANCE BETWEEN SEALANT AREA AND LCD PANEL EDGE X = LCD SIDE LENGTH t = GLASS THICKNESS</p>	a	b	c	$\leq t/2$	< VIEWING AREA	$\leq 1/8X$	$t/2 > , \leq 2t$	$\leq W/2$	$\leq 1/8X$
		a	b	c							
		$\leq t/2$	< VIEWING AREA	$\leq 1/8X$							
		$t/2 > , \leq 2t$	$\leq W/2$	$\leq 1/8X$							
<p>CORNER PART :</p>  <table border="1"> <thead> <tr> <th>a</th> <th>b</th> <th>c</th> </tr> </thead> <tbody> <tr> <td>$\leq t/2$</td> <td>< VIEWING AREA</td> <td>$\leq 1/8X$</td> </tr> <tr> <td>$> t/2 , \leq 2t$</td> <td>$\leq W/2$</td> <td>$\leq 1/8X$</td> </tr> </tbody> </table> <p>*W=DISTANCE BETWEEN SEALANT AREA AND LCD PANEL EDGE X = LCD SIDE LENGTH t = GLASS THICKNESS</p>	a	b	c	$\leq t/2$	< VIEWING AREA	$\leq 1/8X$	$> t/2 , \leq 2t$	$\leq W/2$	$\leq 1/8X$		
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$\leq t/2$	< VIEWING AREA	$\leq 1/8X$									
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<p>CHIP ON ELECTRODE PAD</p>  <table border="1"> <thead> <tr> <th>a</th> <th>b</th> <th>c</th> </tr> </thead> <tbody> <tr> <td>$\leq t$</td> <td>$\leq 0.5\text{mm}$</td> <td>$\leq 1/8X$</td> </tr> </tbody> </table> <p>* X=LCD SIDE WIDTH t=GLASS THICKNESS</p>	a	b	c	$\leq t$	$\leq 0.5\text{mm}$	$\leq 1/8X$					
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a	b	c									
$\leq t$	$\leq 1/8X$	$\leq L$									

12.4 RELIABILITY TEST

12.4.1 STANDARD SPECIFICATIONS FOR RELIABILITY OF LCD MODULE

NO.	ITEM	DESCRIPTION
1	HIGH TEMPERATURE OPERATION	THE SAMPLE SHOULD BE ALLOWED TO STAND AT +70°C FOR 240 HRS
2	LOW TEMPERATURE OPERATION	THE SAMPLE SHOULD BE ALLOWED TO STAND AT -20°C FOR 240 HRS
3	HIGH TEMPERATURE STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT +80°C FOR 240 HRS
4	LOW TEMPERATURE STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT -30°C FOR 240 HRS
5	HIGH TEMPERATURE /HUMIDITY TEST STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT 60°C, 90% RH 240 HRS
6	THERMAL SHOCK (NOT OPERATED)	<p>THE SAMPLE SHOULD BE ALLOWED TO STAND THE FOLLOWING 10 CYCLES OF OPERATION:</p> <p>The diagram shows a temperature profile for one cycle of thermal shock. It starts at -30°C, ramps up to +80°C in 30 minutes, stays at +80°C for 3 minutes, ramps down to -30°C in 30 minutes, and stays at -30°C for 3 minutes. This sequence is labeled as 1 CYCLE.</p>
7	ESD (ELECTROSTATIC DISCHARGE) (NOT OPERATED)	AIR DISCHARGE ± 12KV CONTACT DISCHARGE ± 8KV (ACCORDING TO IEC-61000-4-2)

NOTE (1) : THE TEST SAMPLES HAVE RECOVERY TIME FOR 2 HOURS AT ROOM TEMPERATURE BEFORE THE FUNCTION CHECK. IN THE STANDARD CONDITIONS, THERE IS NO DISPLAY FUNCTION NG ISSUE OCCURRED.

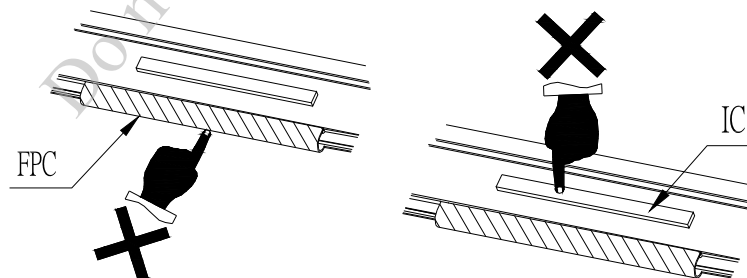
12.5 TESTING CONDITIONS AND INSPECTION CRITERIA

FOR THE FINAL TEST THE TESTING SAMPLE MUST BE STORED AT ROOM TEMPERATURE FOR 24 HOURS, AFTER THE TESTS LISTED IN TABLE 12.4, STANDARD SPECIFICATIONS FOR RELIABILITY HAVE BEEN EXECUTED IN ORDER TO ENSURE STABILITY.

NO.	ITEM	TEST MODEL	INSPECTION CRITERIA
1	CURRENT CONSUMPTION	REFER TO SPECIFICATION	THE CURRENT CONSUMPTION SHOULD CONFORM TO THE PRODUCT SPECIFICATION.
2	CONTRAST	REFER TO SPECIFICATION	AFTER THE TESTS HAVE BEEN EXECUTED, THE CONTRAST MUST BE LARGER THAN HALF OF ITS INITIAL VALUE PRIOR TO THE TESTS.
3	APPEARANCE	VISUAL INSPECTION	DEFECT FREE

12.6 OPERATION

- 12.6.1 DO NOT CONNECT OR DISCONNECT MODULES TO OR FROM THE MAIN SYSTEM WHILE POWER IS BEING SUPPLIED .
- 12.6.2 USE THE MODULE WITHIN SPECIFIED TEMPERATURE ; LOWER TEMPERATURE CAUSES THE RETARDATION OF BLINKING SPEED OF THE DISPLAY ; HIGHER TEMPERATURE MAKES OVERALL DISPLAY DISCOLOR . WHEN THE TEMPERATURE RETURNS TO NORMALITY, THE DISPLAY WILL OPERATE NORMALLY.
- 12.6.3 ADJUST THE LC DRIVING VOLTAGE TO OBTAIN THE OPTIMUM CONTRAST .
- 12.6.4 POWER ON SEQUENCE INPUT SIGNALS SHOULD NOT BE SUPPLIED TO LCD MODULE BEFORE POWER SUPPLY VOLTAGE IS APPLIED AND REACHES THE SPECIFIED VALUE.
IF ABOVE SEQUENCE IS NOT FOLLOWED , CMOS LSIS OF LCD MODULES MAY BE DAMAGED DUE TO LATCH - UP PROBLEM.
- 12.6.5 NOT ALLOWED TO INFLICT ANY EXTERNAL STRESS AND TO CAUSE ANY MECHANICAL INTERFERENCE ON THE BENDING AREA OF FPC DURING THE TAIL BENDING BACKWARDS!
DO NOT STRESS FPC AND IC ON THE MODULE!



12.7 NOTICE

- 12.7.1 USE A GROUNDED SOLDERING IRON WHEN SOLDERING CONNECTOR I/O TERMINALS . FOR SOLDERING OR REPAIRING, TAKE PRECAUTION AGAINST THE TEMPERATURE OF THE SOLDERING IRON AND THE SOLDERING TIME TO PREVENT PEELING OFF THE THROUGH-HOLE-PAD.
- 12.7.2 DO NOT DISASSEMBLE . EDT SHALL NOT BE HELD RESPONSIBLE IF THE MODULE IS DISASSEMBLED AND UPON THE REASSEMBLY THE MODULE FAILED.
- 12.7.3 DO NOT CHARGE STATIC ELECTRICITY, AS THE CIRCUIT OF THIS MODULE CONTAINS CMOS LSIS. A WORKMAN'S BODY SHOULD ALWAYS BE STATIC-PROTECTED BY USE OF AN ESD STRAP. WORKING CLOTHES FOR SUCH PERSONNEL SHOULD BE OF STATIC-PROTECTED MATERIAL.
- 12.7.4 ALWAYS GROUND THE ELECTRICALLY-POWERED DRIVER BEFORE USING IT TO INSTALL THE LCD MODULE. WHILE CLEANING THE WORK STATION BY VACUUM CLEANER, DO NOT BRING THE SUCKING MOUTH NEAR THE MODULE ; STATIC ELECTRICITY OF THE ELECTRICALLY-POWERED DRIVER OR THE VACUUM CLEANER MAY DESTROY THE MODULE.
- 12.7.5 DON'T GIVE EXTERNAL SHOCK.
- 12.7.6 DON'T APPLY EXCESSIVE FORCE ON THE SURFACE.
- 12.7.7 LIQUID IN LCD IS HAZARDOUS SUBSTANCE. MUST NOT LICK AND SWALLOW.
WHEN THE LIQUID IS ATTACH TO YOUR, SKIN, CLOTH ETC. WASH IT OUT THOROUGHLY AND IMMEDIATELY.
- 12.7.8 DON'T OPERATE IT ABOVE THE ABSOLUTE MAXIMUM RATING.
- 12.7.9 STORAGE IN A CLEAN ENVIRONMENT, FREE FROM DUST, ACTIVE GAS, AND SOLVENT.
- 12.7.10 STORE WITHOUT ANY PHYSICAL LOAD.
- 12.7.11 REWIRING: NO MORE THAN 3 TIMES.